

# SANYO Semiconductors DATA SHEET

# 2SC4390 — NPN Epitaxial Planar Silicon Transistor High hFE, AF Amplifier Applications

#### **Features**

- · Adoption of MBIT process.
- High DC current gain (hFE=800 to 3200).
- Large current capacity (IC=2A).
- · Low collector-to-emitter saturation voltage (VCE(sat)≤0.3V).
- · High VEBO (VEBO≥15V).

### **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

| Parameter                    | Symbol | Conditions                                | Ratings     | Unit |
|------------------------------|--------|---|-------------|------|
| Collector-to-Base Voltage    | VCBO   |   | 20          | V    |
| Collector-to-Emitter Voltage | VCEO   |   | 10          | V    |
| Emitter-to-Base Voltage      | VEBO   |   | 15          | V    |
| Collector Current            | IC     |   | 2           | Α    |
| Collector Current (Pulse)    | ICP    |   | 4           | Α    |
| Base Current                 | IΒ     |   | 0.4         | Α    |
| Collector Dissipation        | D-     |   | 500         | mW   |
|                              | PC     | Mounted on a ceramic board (250mm²×0.8mm) | 1.3         | W    |
| Junction Temperature         | Tj     |   | 150         | °C   |
| Storage Temperature          | Tstg   |   | -55 to +150 | °C   |

#### Electrical Characteristics at Ta=25°C

| Parameter                | Symbol | Conditions                               | Ratings |     |     | Unit |
|--------------------------|--------|--|---------|-----|-----|------|
|                          |        |  | min     | typ | max | Uill |
| Collector Cutoff Current | ICBO   | V <sub>CB</sub> =15V, I <sub>E</sub> =0A |         |     | 0.1 | μΑ   |
| Emitter Cutoff Current   | IEBO   | V <sub>EB</sub> =10V, I <sub>C</sub> =0A |         |     | 0.1 | μΑ   |

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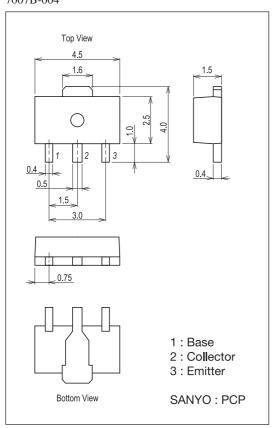
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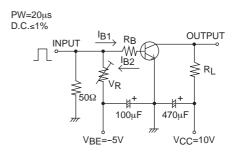
| Parameter                               | Symbol                | Conditions                                 | Ratings |      |      | Linit |
|---|-----------------------|--|---------|------|------|-------|
|   |                       |  | min     | typ  | max  | Unit  |
| DC Current Gain                         | hFE1                  | V <sub>CE</sub> =2V, I <sub>C</sub> =500mA | 800     | 1500 | 3200 |       |
|   | hFE2                  | V <sub>CE</sub> =2V, I <sub>C</sub> =2A    | 400     |      |      |       |
| Gain-Bandwidth Product                  | fT                    | V <sub>CE</sub> =10V, I <sub>C</sub> =50mA |         | 260  |      | MHz   |
| Output Capacitance                      | Cob                   | V <sub>CB</sub> =10V, f=1MHz               |         | 28   |      | pF    |
| Collector-to-Emitter Saturation Voltage | V <sub>CE</sub> (sat) | I <sub>C</sub> =1A, I <sub>B</sub> =20mA   |         | 0.11 | 0.5  | V     |
| Base-to-Emitter Saturation Voltage      | V <sub>BE</sub> (sat) | I <sub>C</sub> =1A, I <sub>B</sub> =20mA   |         | 0.87 | 1.2  | V     |
| Collector-to-Base Breakdown Voltage     | V(BR)CBO              | I <sub>C</sub> =10μA, I <sub>E</sub> =0A   | 20      |      |      | V     |
| Collector-to-Emitter Breakdown Voltage  | V(BR)CEO              | IC=1mA, RBE=∞                              | 10      |      |      | V     |
| Emitter-to-Base Breakdown Voltage       | V(BR)EBO              | I <sub>E</sub> =10μA, I <sub>C</sub> =0A   | 15      |      |      | V     |
| Turn-ON Time                            | ton                   | See specified Test Circuit.                |         | 0.13 |      | μS    |
| Storage Time                            | t <sub>stg</sub>      | See specified Test Circuit.                |         | 0.8  |      | μS    |
| Fall Time                               | tf                    | See specified Test Circuit.                |         | 0.1  |      | μS    |

#### **Package Dimensions**

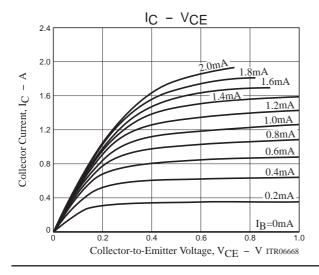
unit : mm (typ) 7007B-004

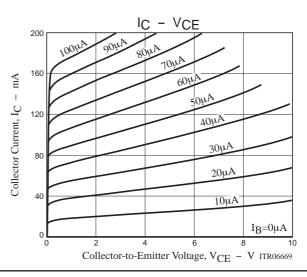


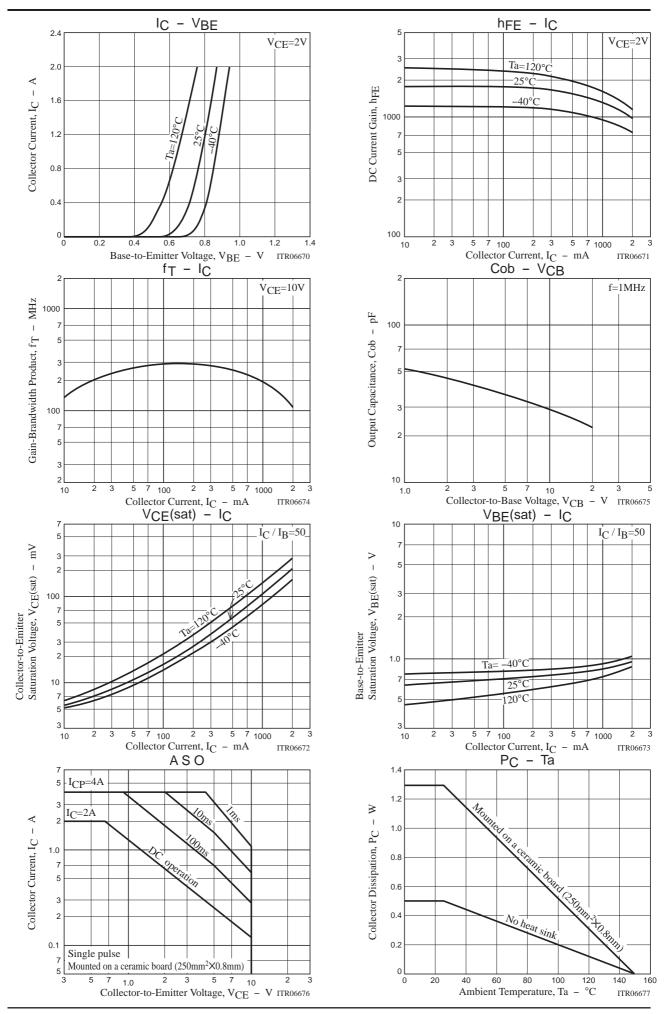
## **Switching Time Test Circuit**



IC=100IB1=-100IB2=700mA







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